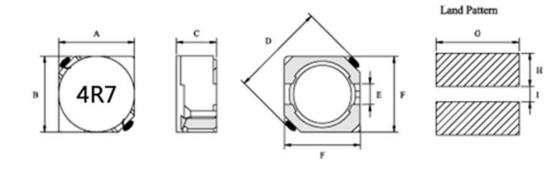


FEATRLRES

- Magnetic Shielded surface mount inductor with high current rating.
- Low resistance to keep power loss minimum.
- 100% Lead(Pb) & Halogen-Free and RoHS compliant.

CONFIGRLRATIONS & DIMENSIONS (unit in mm)



Туре	A±0.3	B±0.3	C(max)	D(max)	E(Ref.)	F(Ref.)	G	Н	1
HRH5D18	5.7	5.7	2.0	8.2	2.0	5.5	6.3	2.15	2.0

ELECTRICAL CHARACTERISTICS

Part Number	Industance (::U)	Toloropoo (9/)	Test Frequency	DCR	IDC	
Part Number	Inductance (uH)	Tolerance (%)	(Hz)	(Ω) max.	(A) max.	
HRH5D18-4R1Y	4.1	± 30%	0.1V/10K	0.057	1.95	
HRH5D18-5R4Y	5.4	± 30%	0.1V/10K	0.076	1.60	
HRH5D18-6R2Y	6.2	± 30%	0.1V/10K	0.096	1.40	
HRH5D18-8R9Y	8.9	± 30%	0.1V/10K	0.116	1.25	
HRH5D18-100Y	10	± 30%	0.1V/10K	0.124	1.20	
HRH5D18-120Y	12	± 30%	0.1V/10K	0.153	1.10	
HRH5D18-150Y	15	± 30%	0.1V/10K	0.196	0.97	
HRH5D18-180Y	18	± 30%	0.1V/10K	0.210	0.85	
HRH5D18-220Y	22	± 30%	0.1V/10K	0.290	0.80	
HRH5D18-270Y	27	± 30%	0.1V/10K	0.330	0.75	
HRH5D18-330Y	33	± 30%	0.1V/10K	0.386	0.65	
HRH5D18-390Y	39	± 30%	0.1V/10K	0.520	0.57	
HRH5D18-470Y	47	± 30%	0.1V/10K	0.595	0.54	
HRH5D18-560Y	56	± 30%	0.1V/10K	0.665	0.50	
HRH5D18-680Y	68	± 30%	0.1V/10K	0.840	0.43	
HRH5D18-820Y	82	± 30%	0.1V/10K	0.978	0.41	



HRH5D18-101Y 100 ± 30% 0.1V/10K 1.200 0.36

Note:

Based on inductance change $(\triangle L/L0 : \le -35\%)$ @ ambient temp. 25°C Based on temperature rise $(\triangle T : 40$ °C typ.)

Reliability and Test Condition

Item	Performance	Test Condition					
Operating temperature	-40~+125℃ (Including self - temperature rise)						
Storage temperature	110~+40°C,50~60%RH (Product with taping) 240~+125°C (on board)						
Electrical Performance Test							
Inductance	Refer to standard electrical characteristics list.	HP4284A,CH11025,CH3302,CH1320,CH1320S LCR Meter.					
DCR	recei to standard electrical differences list.	CH16502,Agilent33420A Micro-Ohm Meter.					
Saturation Current (Isat)	Approximately△L30%	Saturation DC Current (Isat) will cause L0 to drop △L(%)					
Heat Rated Current (Irms)	Heat Rated Current (Irms) will cause the coil temperal 1.Applied the allowed DC current 2.Temperature measured by digital surface thermom						
Reliability Test							
Life Test		Preconditioning: Run through IR reflow for 2 times.(IPC/JEDEC J-STD-020DClassification Reflow Profiles) Temperature: 125±2°C (Inductor) Applied current: rated current Duration: 1000±12hrs Measured at room temperature after placing for 24±2 hrs					
Load Humidity		Preconditioning: Run through IR reflow for 2 times.(IPC/JEDEC J-STD-020DClassification Reflow Profiles Humidity: 85±2 * R.H, Temperature: 85°C±2°C Duration: 1000hrs Min. with 100% rated current Measured at room temperature after placing for 24±2 hrs					
Moisture Resistance	Appearance: No damage. Inductance: within±10% of initial value Q: Shall not exceed the specification value. RDC: within±15% of initial value and shall not exceed the specification value	Preconditioning: Run through IR reflow for 2 times.(IPC/JEDEC J-STD-020DClassification Reflow Profiles 1. Baked at50° $\mathbb C$ for 25hrs, measured at room temperature after placing for 4 hrs. 2. Raise temperature to $65\pm2°\mathbb C$ 90-100%RH in 2.5hrs, and keep 3 hours, cool down to $25°\mathbb C$ in 2.5hrs. 3. Raise temperature to $65\pm2°\mathbb C$ 90-100%RH in 2.5hrs, and keep 3 hours, cool down to $25°\mathbb C$ in 2.5hrs heep at $25°\mathbb C$ for 2 hrs then keep at $-10°\mathbb C$ for 3 hrs 4. Keep at $25°\mathbb C$ 80-100%RH for 15min and vibrate at the frequency of 10 to 55 Hz to 10 Hz, measure at room temperature after placing for 1~2 hrs.					
Thermal shock		Preconditioning: Run through IR reflow for 2 times.(IPC/JEDEC J-STD-020DClassification Reflow Profiles Condition for 1 cycle Step1: -40±2°C 30±5min Step2: 25±2°C ≤0.5min Step3: 125±2°C 30±5min Number of cycles: 500 Measured at room temperature after placing for 24±2 hrs					
Vibration		Oscillation Frequency: 10 ~ 2K ~ 10Hz for 20 minutes Equipment: Vibration checker Total Amplitude:1.52mm±10% Testing Time: 12 hours(20 minutes, 12 cycles each of 3 orientations).					
Bending	Appearance : No damage.	Shall be mounted on a FR4 substrate of the following dimensions: >=0805 inch(2012mm):40x100x1.2mm <0805 inch(2012mm):40x100x0.8mm Bending depth: >=0805 inch(2012mm):1.2mm <0805 inch(2012mm):0.8mm duration of 10 sec.					



Shock	Impedance: within±15% of initial value Inductance: within±10% of initial value Q: Shall not exceed the specification value. RDC: within ±15% of initial value and shall not exceed the specification value		Type SMD Lead	Peak value (g's) 50	Norm duration (ms 11	n (D) s)	Wave form Half-sine Half-sine	Velocity change (Vi)ft/sec 11.3	
Solder ability	More than 95% of the terminal electrode should be covered with solder.	Preheat: 150°C,60sec Solder: Sn96.5% Ag3% Cu0.5% Temperature: 245±5°C ∘ Flux for lead free: Rosin. 9.5% ∘ Dip time: 4±1sec ∘ Depth: completely cover the termination Depth: completely cover the termination							
Resistance to Soldering Heat			Tempe	erature(°C) 60 ±5 ler temp)		Ter ramp and er	mperature /immersion mersion ra	te heat cycles	
Terminal Strength	Appearance: No damage. Impedance: within±15% of initial value Inductance: within±10% of initial value Q: Shall not exceed the specification value. RDC: within ±15% of initial value and shall not exceed the specification value e	Preconditioning: Run through IR reflow for 2 times.(IPC/JEDEC J-S' 020DClassification Reflow Profiles With the component mounted on a PCB with the device to be test apply a force(>0805:1kg , <=0805:0.5kg)to the side of a device be tested. This force shall be applied for 60 +1 seconds. Also the force sibe applied gradually as not to apply a shock to the component be tested.				e tested, ice being orce shall			

Note: When there are questions concerning measurement result: measurement shall be made after 48 ± 2 hours of recovery under the standard condition.